

Electronic Patent Application Fee Transmittal				
Application Number:	10588927			
Filing Date:	03-Aug-2007			
Title of Invention:	Semiconductor Package with Perforated Substrate			
First Named Inventor/Applicant Name:	Irwin Aberin			
Filer:	Steven Edward Dicke/Katy Henry			
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
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Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Submission- Information Disclosure Stmt	1806	1	180	180
Total in USD (\$)				180